

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SURFBOARDS ®

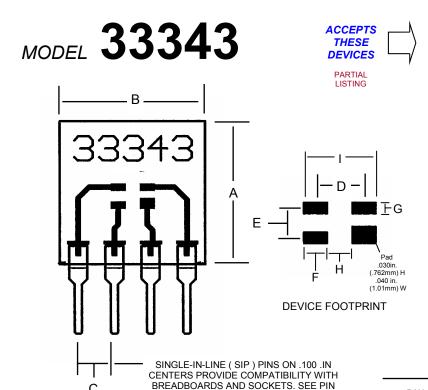


THE BREADBOARDING MEDIUM FOR **SURFACE MOUNT** TM

33000 SERIES APPLICATION SPECIFIC ADAPTERS

IDS33343

REV 1-2012



SPECIFICATIONS TABLE.

PAD WIDTH

MAX PIN WIDTH

SOT-343 SC-70-4 **SC-82 AB**

ANALOG KS-4 PKG. ON SEMI CASE **419C-02** PANASONIC SMini-4 PKG. ROHM **UMD4** PKG. TOSHIBA **USQ** PKG.

> ALWAYS CONSULT DEVICE DATA SHEET TO INSURE PROPER FIT

PROTOTYPING AND **DEVICE EVALUATION AND TEST ADAPTER**

FIG. **INCHES** NOTE: MM Α .400 10.16 BOARD HEIGHT +- .5mm .020in В 10.16 BOARD WIDTH +- .5mm .020in. .400 С .100 2.54 SIP PIN SPACE +- .20mm .008in PAD CENTERLINE ח .080 2.03 Е .051 1.3 **DEVICE LEAD PITCH** .040 1.01 PAD LENGTH

508

1.01

3.04

C

020

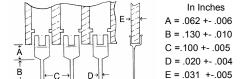
.040

.120

G

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PIN SPECIFICATIONS / TOLERANCES

BOARD SPECIFICATIONS

BOARD MATERIAL: .8mm, +-.13mm .031in+-..005 in. Thick G-10 FR-4 Glass Epoxy or equivalent. CIRCUITS: 1 oz. Copper with RoHS compliant Lead Free solder coating. Patten Position on board +-5mm 020in

TOLERANCES: If not noted are +- 20%. Nominal values are given. Controlling unit is Millimeters. Values rounded to nearest decimal. Slight Variations due to manufacturing process can occur.

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